

# ESP-WROOM-32 Datasheet



**Espressif Systems**

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# About This Guide

This document provides introduction to the specifications of the ESP-WROOM-32 module.

The document structure is as follows:

| Chapter   | Title                      | Subject   |
|-----------|----------------------------|---|
| Chapter 1 | Preface                    | An overview of ESP-WROOM-32                                   |
| Chapter 2 | Pin Definitions            | Device pinout and pin descriptions                            |
| Chapter 3 | Functional Description     | Description of major functional modules and protocols         |
| Chapter 4 | Electrical Characteristics | Electrical characteristics and specifications of ESP-WROOM-32 |
| Chapter 5 | Schematics                 | The schematics of ESP-WROOM-32                                |
| Chapter 6 | Learning Resources         | ESP32-related must-read materials and must-have resources     |

## Release Notes

| Date    | Version | Release notes  |
|---------|---------|--|
| 2016.08 | V1.0    | First release.   |
| 2016.11 | V1.1    | Updated Chapter 5.   |
| 2016.11 | V1.2    | Added <a href="#">Peripheral Schematics</a> .  |
| 2016.12 | V1.3    | Updated Section 2.1.   |
| 2017.03 | V1.4    | Updated Chapter 1;<br>Updated Chapter 2;<br>Updated Chapter 3;<br>Updated Table 4.2;<br>Updated Table 4.4;<br>Updated Section 4.6;<br>Added Chapter <a href="#">Learning Resources</a> ;<br>Updated Table 3. |

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# 1. Preface

ESP-WROOM-32 is a powerful, generic Wi-Fi+BT+BLE MCU module that targets a wide variety of applications, ranging from low-power sensor networks to the most demanding tasks, such as voice encoding, music streaming and MP3 decoding.

At the core of this module is the ESP32-D0WDQ6 chip\*, which is designed to be scalable and adaptive. There are two CPU cores that can be individually controlled or powered, and the clock frequency is adjustable from 80 MHz to 240 MHz. The user may also power off the CPU and make use of the low-power coprocessor to constantly monitor the peripherals for changes or crossing of thresholds. ESP32 integrates a rich set of peripherals, ranging from capacitive touch sensors, Hall sensors, low-noise sense amplifiers, SD card interface, Ethernet, high speed SDIO/SPI, UART, I2S and I2C.

**Note:**

\* For details on the part number of the ESP32 series, please refer to the document [ESP32 Datasheet](#).

The integration of Bluetooth, Bluetooth LE and Wi-Fi ensures that a wide range of applications can be targeted, and that the module is future proof: using Wi-Fi allows a large physical range and direct connection to the internet through a Wi-Fi router, while using Bluetooth allows the user to conveniently connect to the phone or broadcast low energy beacons for its detection. The sleep current of the ESP32 chip is less than 5  $\mu$ A, making it suitable for battery powered and wearable electronics applications. ESP-WROOM-32 supports data rates of up to 150 Mbps, and 22 dBm output power at the PA to ensure the widest physical range. As such the chip does offer industry-leading specifications and the best performance for electronic integration, range, power consumption, and connectivity.

The operating system chosen for ESP32 is freeRTOS with LWIP; TLS 1.2 with hardware acceleration is built in as well. Secure (encrypted) over the air (OTA) upgrade is also supported, so that developers can continually upgrade their products even after their release.

Table 1 provides the specifications of ESP-WROOM-32.

**Table 1: ESP-WROOM-32 Specifications**

| Categories | Items           | Specifications  |
|------------|-----------------|---|
| Wi-Fi      | Standards       | FCC/CE/IC/TELEC/KCC/SRRC/NCC  |
|            | Protocols       | 802.11 b/g/n/d/e/i/k/r (802.11n up to 150 Mbps)<br>A-MPDU and A-MSDU aggregation and 0.4 $\mu$ s guard interval support |
|            | Frequency range | 2.4 ~ 2.5 GHz   |
| Bluetooth  | Protocols       | Bluetooth v4.2 BR/EDR and BLE specification   |
|            | Radio           | NZIF receiver with -98 dBm sensitivity  |
|            |                 | Class-1, class-2 and class-3 transmitter  |
|            |                 | AFH   |
| Audio      | CVSD and SBC    |   |

| Categories   | Items                       | Specifications   |
|--------------|-----------------------------|--|
| Hardware     | Module interface            | SD card, UART, SPI, SDIO, I2C, LED PWM, Motor PWM, I2S, I2C, IR          |
|              |                             | GPIO, capacitive touch sensor, ADC, DAC, LNA pre-amplifier               |
|              | On-chip sensor              | Hall sensor, temperature sensor  |
|              | On-board clock              | 40 MHz crystal   |
|              | Operating voltage           | 2.2 ~ 3.6V   |
|              | Operating current           | Average: 80 mA   |
|              | Operating temperature range | -40°C ~ 85°C *   |
|              | Ambient temperature range   | Normal temperature   |
| Package size | 18 mm x 25.5 mm x 2.8 mm    |  |
| Software     | Wi-Fi mode                  | Station/SoftAP/SoftAP+Station/P2P  |
|              | Security                    | WPA/WPA2/WPA2-Enterprise/WPS   |
|              | Encryption                  | AES/RSA/ECC/SHA  |
|              | Firmware upgrade            | UART Download / OTA (via network) / download and write firmware via host |
|              | Software development        | Supports Cloud Server Development / SDK for custom firmware development  |
|              | Network protocols           | IPv4, IPv6, SSL, TCP/UDP/HTTP/FTP/MQTT                                   |
|              | User configuration          | AT instruction set, cloud server, Android/iOS app                        |

## 2. Pin Definitions

### 2.1 Pin Layout

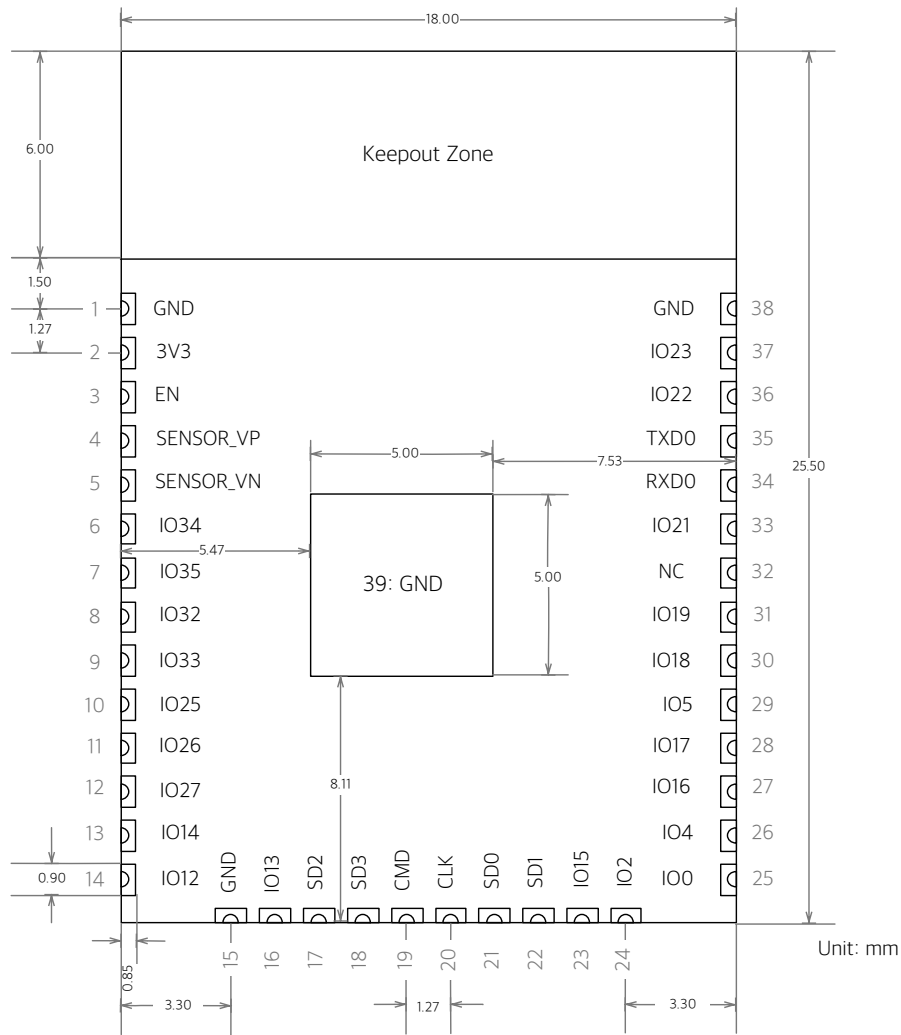


Figure 1: Top and Side View of ESP-WROOM-32

Table 2: ESP-WROOM-32 Dimensions

| Length | Width   | Height       | PAD size (bottom) | Pin pitch | Shielding can height | PCB thickness |
|--------|---------|--------------|-------------------|-----------|----------------------|---------------|
| 18 mm  | 25.5 mm | 2.8 ± 0.1 mm | 0.85 mm x 0.9 mm  | 1.27 mm   | 2 mm                 | 0.8 ± 0.1 mm  |



## 2.2 Pin Description

ESP-WROOM-32 has 39 pins. See pin definitions in Table 3.

**Table 3: ESP-WROOM-32 Pin Definitions**

| Name      | No. | Type | Function   |
|-----------|-----|------|--|
| GND       | 1   | P    | Ground   |
| 3V3       | 2   | P    | Power supply.  |
| EN        | 3   | I    | Chip-enable signal. Active high.   |
| SENSOR_VP | 4   | I    | GPIO36, SENSOR_VP, ADC_H, ADC1_CH0, RTC_GPIO0  |
| SENSOR_VN | 5   | I    | GPIO39, SENSOR_VN, ADC1_CH3, ADC_H, RTC_GPIO3  |
| IO34      | 6   | I    | GPIO34, ADC1_CH6, RTC_GPIO4  |
| IO35      | 7   | I    | GPIO35, ADC1_CH7, RTC_GPIO5  |
| IO32      | 8   | I/O  | GPIO32, XTAL_32K_P (32.768 kHz crystal oscillator input), ADC1_CH4, TOUCH9, RTC_GPIO9  |
| IO33      | 9   | I/O  | GPIO33, XTAL_32K_N (32.768 kHz crystal oscillator output), ADC1_CH5, TOUCH8, RTC_GPIO8 |
| IO25      | 10  | I/O  | GPIO25, DAC_1, ADC2_CH8, RTC_GPIO6, EMAC_RXD0  |
| IO26      | 11  | I/O  | GPIO26, DAC_2, ADC2_CH9, RTC_GPIO7, EMAC_RXD1  |
| IO27      | 12  | I/O  | GPIO27, ADC2_CH7, TOUCH7, RTC_GPIO17, EMAC_RX_DV                                       |
| IO14      | 13  | I/O  | GPIO14, ADC2_CH6, TOUCH6, RTC_GPIO16, MTMS, HSPICLK, HS2_CLK, SD_CLK, EMAC_TXD2        |
| IO12      | 14  | I/O  | GPIO12, ADC2_CH5, TOUCH5, RTC_GPIO15, MTDI, HSPIQ, HS2_DATA2, SD_DATA2, EMAC_TXD3      |
| GND       | 15  | P    | Ground   |
| IO13      | 16  | I/O  | GPIO13, ADC2_CH4, TOUCH4, RTC_GPIO14, MTCK, HSPID, HS2_DATA3, SD_DATA3, EMAC_RX_ER     |
| SHD/SD2   | 17  | I/O  | GPIO9, SD_DATA2, SPIHD, HS1_DATA2, U1RXD   |
| SWP/SD3   | 18  | I/O  | GPIO10, SD_DATA3, SPIWP, HS1_DATA3, U1TXD  |
| SCS/CMD   | 19  | I/O  | GPIO11, SD_CMD, SPICS0, HS1_CMD, U1RTS   |
| SCK/CLK   | 20  | I/O  | GPIO6, SD_CLK, SPICLK, HS1_CLK, U1CTS  |
| SDO/SD0   | 21  | I/O  | GPIO7, SD_DATA0, SPIQ, HS1_DATA0, U2RTS  |
| SDI/SD1   | 22  | I/O  | GPIO8, SD_DATA1, SPID, HS1_DATA1, U2CTS  |
| IO15      | 23  | I/O  | GPIO15, ADC2_CH3, TOUCH3, MTDO, HSPICS0, RTC_GPIO13, HS2_CMD, SD_CMD, EMAC_RXD3        |
| IO2       | 24  | I/O  | GPIO2, ADC2_CH2, TOUCH2, RTC_GPIO12, HSPIWP, HS2_DATA0, SD_DATA0                       |
| IO0       | 25  | I/O  | GPIO0, ADC2_CH1, TOUCH1, RTC_GPIO11, CLK_OUT1, EMAC_TX_CLK                             |
| IO4       | 26  | I/O  | GPIO4, ADC2_CH0, TOUCH0, RTC_GPIO10, HSPIHD, HS2_DATA1, SD_DATA1, EMAC_TX_ER           |
| IO16      | 27  | I/O  | GPIO16, HS1_DATA4, U2RXD, EMAC_CLK_OUT   |
| IO17      | 28  | I/O  | GPIO17, HS1_DATA5, U2TXD, EMAC_CLK_OUT_180   |
| IO5       | 29  | I/O  | GPIO5, VSPICS0, HS1_DATA6, EMAC_RX_CLK   |
| IO18      | 30  | I/O  | GPIO18, VSPICLK, HS1_DATA7   |
| IO19      | 31  | I/O  | GPIO19, VSPIQ, U0CTS, EMAC_TXD0  |

| Name | No. | Type | Function                          |
|------|-----|------|-----------------------------------|
| NC   | 32  | -    | -                                 |
| IO21 | 33  | I/O  | GPIO21, VSPIHD, EMAC_TX_EN        |
| RXD0 | 34  | I/O  | GPIO3, U0RXD, CLK_OUT2            |
| TXD0 | 35  | I/O  | GPIO1, U0TXD, CLK_OUT3, EMAC_RXD2 |
| IO22 | 36  | I/O  | GPIO22, VSPIWP, U0RTS, EMAC_TXD1  |
| IO23 | 37  | I/O  | GPIO23, VSPID, HS1_STROBE         |
| GND  | 38  | P    | Ground                            |
| GND  | 39  | P    | Ground                            |

## 2.3 Strapping Pins

ESP32-D0WDQ6 has five strapping pins. Software can read the value of these five bits from the register "GPIO\_STRAPPING". During the chip power-on reset, the latches of the strapping pins sample the voltage level as strapping bits of "0" or "1", and hold these bits until the chip is powered down or shut down.

Each strapping pin is connected with its internal pull-up/pull-down during the chip reset. Consequently, if a strapping pin is unconnected or the connected external circuit is high-impedance, the internal weak pull-up/pull-down will determine the default input level of the strapping pins.

To change the strapping bit values, users can apply the external pull-down/pull-up resistances, or apply the host MCU's GPIOs to control the voltage level of these pins when powering ESP32 on.

After reset, the strapping pins work as the normal functions pins.

Refer to Table 4 for detailed boot modes of configuration by strapping pins.

**Table 4: Strapping Pins**

| Voltage of Internal LDO (VDD_SDIO)     |           |   |  |  |   |
|--|-----------|---|--|--|---|
| Pin                                    | Default   | 3.3V                                      |  | 1.8V                                     |   |
| MTDI                                   | Pull-down | 0   |  | 1  |   |
| Bootling Mode                          |           |   |  |  |   |
| Pin                                    | Default   | SPI Flash Boot                            |  | Download Boot                            |   |
| GPIO0                                  | Pull-up   | 1   |  | 0  |   |
| GPIO2                                  | Pull-down | Don't-care                                |  | 0  |   |
| Debugging Log on U0TXD During Bootling |           |   |  |  |   |
| Pin                                    | Default   | U0TXD Toggling                            |  | U0TXD Silent                             |   |
| MTDO                                   | Pull-up   | 1   |  | 0  |   |
| Timing of SDIO Slave                   |           |   |  |  |   |
| Pin                                    | Default   | Falling-edge Input<br>Falling-edge Output | Falling-edge Input<br>Rising-edge Output | Rising-edge Input<br>Falling-edge Output | Rising-edge Input<br>Rising-edge Output |
| MTDO                                   | Pull-up   | 0   | 0  | 1  | 1                                       |
| GPIO5                                  | Pull-up   | 0   | 1  | 0  | 1                                       |

**Note:**

Firmware can configure register bits to change the settings of "Voltage of Internal LDO (VDD\_SDIO)" and "Timing of SDIO Slave" after bootling.

## 3. Functional Description

This chapter describes the modules and functions integrated in ESP-WROOM-32.

### 3.1 CPU and Internal Memory

ESP32-D0WDQ6 contains two low-power Xtensa® 32-bit LX6 microprocessors. The internal memory includes:

- 448 KB of ROM for booting and core functions.
- 520 KB of on-chip SRAM for data and instruction.
- 8 KB of SRAM in RTC, which is called RTC SLOW Memory and can be accessed by the co-processor during the Deep-sleep mode.
- 8 KB of SRAM in RTC, which is called RTC FAST Memory and can be used for data storage; it is accessed by the main CPU during RTC Boot from the Deep-sleep mode.
- 1 kbit of eFuse, of which 256 bits are used for the system (MAC address and chip configuration) and the remaining 768 bits are reserved for customer applications, including Flash-Encryption and Chip-ID.

### 3.2 External Flash and SRAM

ESP32-D0WDQ6 supports up to four 16-MB external QSPI flash and SRAM with hardware encryption based on AES to protect developer's programs and data.

ESP32 can access the external QSPI flash and SRAM through high-speed caches.

- Up to 16 MB of external flash are memory-mapped onto the CPU code space, supporting 8, 16 and 32-bit access. Code execution is supported.
- Up to 8 MB of external flash/SRAM are memory-mapped onto the CPU data space, supporting 8, 16 and 32-bit access. Data-read is supported on the flash and SRAM. Data-write is supported on the SRAM.

ESP-WROOM-32 integrates 4 MB of external SPI flash. The 4-MB SPI flash can be memory-mapped onto the CPU code space, supporting 8, 16 and 32-bit access. Code execution is supported.

### 3.3 Crystal Oscillators

The frequencies of the main crystal oscillator supported include 40 MHz, 26 MHz and 24 MHz. The accuracy of crystal oscillators applied should be  $\pm 10$  PPM, and the operating temperature ranges from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

When using the downloading tools, remember to select the right crystal oscillator type. In circuit design, capacitors C1 and C2 that connect to the earth are added to the input and output terminals of the crystal oscillator, respectively. The values of the two capacitors can be flexible, ranging from 6 pF to 22 pF. However, the specific capacitive values of C1 and C2 depend on further tests and adjustments of the overall performance of the whole circuit. Normally, the capacitive values of C1 and C2 are within 10 pF when the crystal oscillator frequency is 26 MHz, or  $10\text{ pF} < \text{C1 and C2} < 22\text{ pF}$  when the crystal oscillator frequency is 40 MHz.

The frequency of the RTC crystal oscillator is typically 32 kHz or 32.768 kHz. The accuracy can be out of the range of  $\pm 20$  PPM, when the internal calibration is applied to correct the frequency offset. When the chip operates in

low-power modes, the application chooses the external low-speed (32 kHz) crystal clock, rather than the internal RC oscillators, to achieve the accurate wakeup time.

### 3.4 Power Consumption

With the advanced power management technology, ESP32-D0WDQ6 can switch between different power modes as follows:

- Power mode
  - Active mode: chip radio is powered on. The chip can receive, transmit, or listen.
  - Modem-sleep mode: the CPU is operational and the clock is configurable. Wi-Fi / Bluetooth baseband and radio are disabled.
  - Light-sleep mode: the CPU is paused. The RTC and ULP-coprocessor are running. Any wake-up events (MAC, host, RTC timer, or external interrupts) will wake up the chip.
  - Deep-sleep mode: Only RTC is powered on. Wi-Fi and Bluetooth connection data are stored in RTC memory. The ULP-coprocessor can work.
  - Hibernation mode: The internal 8MHz oscillator and ULP-coprocessor are disabled. The RTC recovery memory is powered down. Only one RTC timer on the slow clock and some RTC GPIOs are active. The RTC timer or the RTC GPIOs can wake up the chip from the Hibernation mode.
- Sleep Pattern
  - Association sleep pattern: The power mode switches between the active mode and Modem-sleep/Light-sleep mode during this sleep pattern. The CPU, Wi-Fi, Bluetooth, and radio wake up at pre-determined intervals to keep Wi-Fi / BT connections on.
  - ULP sensor-monitored pattern: The main CPU is in the Deep-sleep mode. The ULP co-processor does sensor measurements and wakes up the main system, based on the measured data from sensors.

The power consumption varies with different power modes/sleep patterns, and work status, of functional modules (see Table 5).

**Table 5: Power Consumption by Power Modes**

| Power mode               | Comment                                    | Power consumption          |
|--------------------------|--|----------------------------|
| Active mode (RF working) | Wi-Fi Tx packet 13 dBm ~ 21 dBm            | 160 ~ 260 mA               |
|                          | Wi-Fi / BT Tx packet 0 dBm                 | 120 mA                     |
|                          | Wi-Fi / BT Rx and listening                | 80 ~ 90 mA                 |
|                          | Association sleep pattern (by Light-sleep) | 0.9 mA@DTIM3, 1.2 mA@DTIM1 |
| Modem-sleep mode         | The CPU is powered on.                     | Max speed: 20 mA           |
|                          |  | Normal: 5 ~ 10 mA          |
|                          |  | Slow speed: 3 mA           |
| Light-sleep mode         | -  | 0.8 mA                     |
| Deep-sleep mode          | The ULP-coprocessor is powered on.         | 0.15 mA                    |
|                          | ULP sensor-monitored pattern               | 25 $\mu$ A @1% duty        |
|                          | RTC timer + RTC memories                   | 20 $\mu$ A                 |
| Hibernation mode         | RTC timer only                             | 5 $\mu$ A                  |

## 3.5 Peripherals and Sensors

### 3.5.1 Peripherals and Sensors Description

**Table 6: Peripherals and Sensors Description**

| Interface                            | Signal    | Pin       | Function   |
|--------------------------------------|-----------|-----------|--|
| ADC                                  | ADC1_CH0  | SENSOR_VP | Two 12-bit SAR ADCs  |
|                                      | ADC1_CH3  | SENSOR_VN |  |
|                                      | ADC1_CH4  | IO32      |  |
|                                      | ADC1_CH5  | IO33      |  |
|                                      | ADC1_CH6  | IO34      |  |
|                                      | ADC1_CH7  | IO35      |  |
|                                      | ADC2_CH0  | IO4       |  |
|                                      | ADC2_CH1  | IO0       |  |
|                                      | ADC2_CH2  | IO2       |  |
|                                      | ADC2_CH3  | IO15      |  |
|                                      | ADC2_CH4  | IO13      |  |
|                                      | ADC2_CH5  | IO12      |  |
|                                      | ADC2_CH6  | IO14      |  |
|                                      | ADC2_CH7  | IO27      |  |
|                                      | ADC2_CH8  | IO25      |  |
| ADC2_CH9                             | IO26      |           |  |
| Ultra Low Noise Analog Pre-Amplifier | SENSOR_VP | IO36      | Provides about 60dB gain by using larger capacitors on PCB |
|                                      | SENSOR_VN | IO39      |  |
| DAC                                  | DAC_1     | IO25      | Two 8-bit DACs   |
|                                      | DAC_2     | IO26      |  |
| Touch Sensor                         | TOUCH0    | IO4       | Capacitive touch sensors                                   |
|                                      | TOUCH1    | IO0       |  |
|                                      | TOUCH2    | IO2       |  |
|                                      | TOUCH3    | IO15      |  |
|                                      | TOUCH4    | IO13      |  |
|                                      | TOUCH5    | IO12      |  |
|                                      | TOUCH6    | IO14      |  |
|                                      | TOUCH7    | IO27      |  |
|                                      | TOUCH8    | IO33      |  |
|                                      | TOUCH9    | IO32      |  |
| SD / SDIO / MMC Host Controller      | HS2_CLK   | MTMS      | Supports SD memory card V3.01 standard                     |
|                                      | HS2_CMD   | MTDO      |  |
|                                      | HS2_DATA0 | IO2       |  |
|                                      | HS2_DATA1 | IO4       |  |
|                                      | HS2_DATA2 | MTDI      |  |
|                                      | HS2_DATA3 | MTCK      |  |

| Interface | Signal             | Pin      | Function  |
|-----------|--------------------|----------|---|
| Motor PWM | PWM0_OUT0~2        | Any GPIO | Three channels of 16-bit timers generate PWM waveforms; each has a pair of output signals. Three fault detection signals. Three even capture signals. Three sync signals. |
|           | PWM1_OUT_IN0~2     |          |   |
|           | PWM0_FLT_IN0~2     |          |   |
|           | PWM1_FLT_IN0~2     |          |   |
|           | PWM0_CAP_IN0~2     |          |   |
|           | PWM1_CAP_IN0~2     |          |   |
|           | PWM0_SYNC_IN0~2    |          |   |
|           | PWM1_SYNC_IN0~2    |          |   |
| LED PWM   | ledc_hs_sig_out0~7 | Any GPIO | 16 independent channels @80MHz clock/RTC CLK. Duty accuracy: 16 bits.   |
|           | ledc_ls_sig_out0~7 |          |   |
| UART      | U0RXD_in           | Any GPIO | Two UART devices with hardware flow-control and DMA   |
|           | U0CTS_in           |          |   |
|           | U0DSR_in           |          |   |
|           | U0TXD_out          |          |   |
|           | U0RTS_out          |          |   |
|           | U0DTR_out          |          |   |
|           | U1RXD_in           |          |   |
|           | U1CTS_in           |          |   |
|           | U1TXD_out          |          |   |
|           | U1RTS_out          |          |   |
|           | U2RXD_in           |          |   |
|           | U2CTS_in           |          |   |
|           | U2TXD_out          |          |   |
|           | U2RTS_out          |          |   |
| I2C       | I2CEXT0_SCL_in     | Any GPIO | Two I2C devices in slave or master modes  |
|           | I2CEXT0_SDA_in     |          |   |
|           | I2CEXT1_SCL_in     |          |   |
|           | I2CEXT1_SDA_in     |          |   |
|           | I2CEXT0_SCL_out    |          |   |
|           | I2CEXT0_SDA_out    |          |   |
|           | I2CEXT1_SCL_out    |          |   |
|           | I2CEXT1_SDA_out    |          |   |

| Interface          | Signal             | Pin      | Function  |
|--------------------|--------------------|----------|---|
| I2S                | I2S0I_DATA_in0~15  | Any GPIO | Stereo input and output from/to the audio codec, and parallel LCD data output |
|                    | I2S0O_BCK_in       |          |   |
|                    | I2S0O_WS_in        |          |   |
|                    | I2S0I_BCK_in       |          |   |
|                    | I2S0I_WS_in        |          |   |
|                    | I2S0I_H_SYNC       |          |   |
|                    | I2S0I_V_SYNC       |          |   |
|                    | I2S0I_H_ENABLE     |          |   |
|                    | I2S0O_BCK_out      |          |   |
|                    | I2S0O_WS_out       |          |   |
|                    | I2S0I_BCK_out      |          |   |
|                    | I2S0I_WS_out       |          |   |
|                    | I2S0O_DATA_out0~23 |          |   |
|                    | I2S1I_DATA_in0~15  |          |   |
|                    | I2S1O_BCK_in       |          |   |
|                    | I2S1O_WS_in        |          |   |
|                    | I2S1I_BCK_in       |          |   |
|                    | I2S1I_WS_in        |          |   |
|                    | I2S1I_H_SYNC       |          |   |
|                    | I2S1I_V_SYNC       |          |   |
|                    | I2S1I_H_ENABLE     |          |   |
|                    | I2S1O_BCK_out      |          |   |
|                    | I2S1O_WS_out       |          |   |
| I2S1I_BCK_out      |                    |          |   |
| I2S1I_WS_out       |                    |          |   |
| I2S1O_DATA_out0~23 |                    |          |   |
| Remote Controller  | RMT_SIG_IN0~7      | Any GPIO | Eight channels of IR transmitter and receiver for various waveforms           |
|                    | RMT_SIG_OUT0~7     |          |   |

| Interface           | Signal           | Pin      | Function   |
|---------------------|------------------|----------|--|
| Parallel QSPI       | SPIHD            | SHD/SD2  | Supports Standard SPI, Dual SPI, and Quad SPI that can be connected to the external flash and SRAM   |
|                     | SPIWP            | SWP/SD3  |  |
|                     | SPICS0           | SCS/CMD  |  |
|                     | SPICLK           | SCK/CLK  |  |
|                     | SPIQ             | SDO/SD0  |  |
|                     | SPID             | SDI/SD1  |  |
|                     | HSPICLK          | IO14     |  |
|                     | HSPICS0          | IO15     |  |
|                     | HSPIQ            | IO12     |  |
|                     | HSPID            | IO13     |  |
|                     | HSPIHD           | IO4      |  |
|                     | HSPIWP           | IO2      |  |
|                     | VSPICLK          | IO18     |  |
|                     | VSPICS0          | IO5      |  |
|                     | VSPIQ            | IO19     |  |
|                     | VSPID            | IO23     |  |
| VSPIHD              | IO21             |          |  |
| VSPIWP              | IO22             |          |  |
| General Purpose SPI | HSPIQ_in/_out    | Any GPIO | Standard SPI consists of clock, chip-select, MOSI and MISO. These SPIs can be connected to LCD and other external devices. They support the following features:<br>(a) both master and slave modes;<br>(b) 4 sub-modes of the SPI format transfer that depend on the clock phase (CPHA) and clock polarity (CPOL) control;<br>(c) CLK frequencies by a divider;<br>(d) up to 64 bytes of FIFO and DMA. |
|                     | HSPID_in/_out    |          |  |
|                     | HSPICLK_in/_out  |          |  |
|                     | HSPI_CS0_in/_out |          |  |
|                     | HSPI_CS1_out     |          |  |
|                     | HSPI_CS2_out     |          |  |
|                     | VSPIQ_in/_out    |          |  |
|                     | VSPID_in/_out    |          |  |
|                     | VSPICLK_in/_out  |          |  |
|                     | VSPI_CS0_in/_out |          |  |
|                     | VSPI_CS1_out     |          |  |
|                     | VSPI_CS2_out     |          |  |
| JTAG                | MTDI             | IO12     | JTAG for software debugging  |
|                     | MTCK             | IO13     |  |
|                     | MTMS             | IO14     |  |
|                     | MTDO             | IO15     |  |



| Interface    | Signal           | Pin      | Function   |
|--------------|------------------|----------|--|
| SDIO Slave   | SD_CLK           | IO6      | SDIO interface that conforms to the industry standard SDIO 2.0 card specification. |
|              | SD_CMD           | IO11     |  |
|              | SD_DATA0         | IO7      |  |
|              | SD_DATA1         | IO8      |  |
|              | SD_DATA2         | IO9      |  |
|              | SD_DATA3         | IO10     |  |
| EMAC         | EMAC_TX_CLK      | IO0      | Ethernet MAC with MII/RMII interface   |
|              | EMAC_RX_CLK      | IO5      |  |
|              | EMAC_TX_EN       | IO21     |  |
|              | EMAC_TXD0        | IO19     |  |
|              | EMAC_TXD1        | IO22     |  |
|              | EMAC_TXD2        | IO14     |  |
|              | EMAC_TXD3        | IO12     |  |
|              | EMAC_RX_ER       | IO13     |  |
|              | EMAC_RX_DV       | IO27     |  |
|              | EMAC_RXD0        | IO25     |  |
|              | EMAC_RXD1        | IO26     |  |
|              | EMAC_RXD2        | TXD      |  |
|              | EMAC_RXD3        | IO15     |  |
|              | EMAC_CLK_OUT     | IO16     |  |
|              | EMAC_CLK_OUT_180 | IO17     |  |
|              | EMAC_TX_ER       | IO4      |  |
|              | EMAC_MDC_out     | Any GPIO |  |
|              | EMAC_MDI_in      | Any GPIO |  |
|              | EMAC_MDO_out     | Any GPIO |  |
| EMAC_CRS_out | Any GPIO         |          |  |
| EMAC_COL_out | Any GPIO         |          |  |

**Note:**

Functions of Motor PWM, LED PWM, UART, I2C, I2S, general purpose SPI and Remote Controller can be configured to any GPIO.

### 3.5.2 Peripheral Schematics

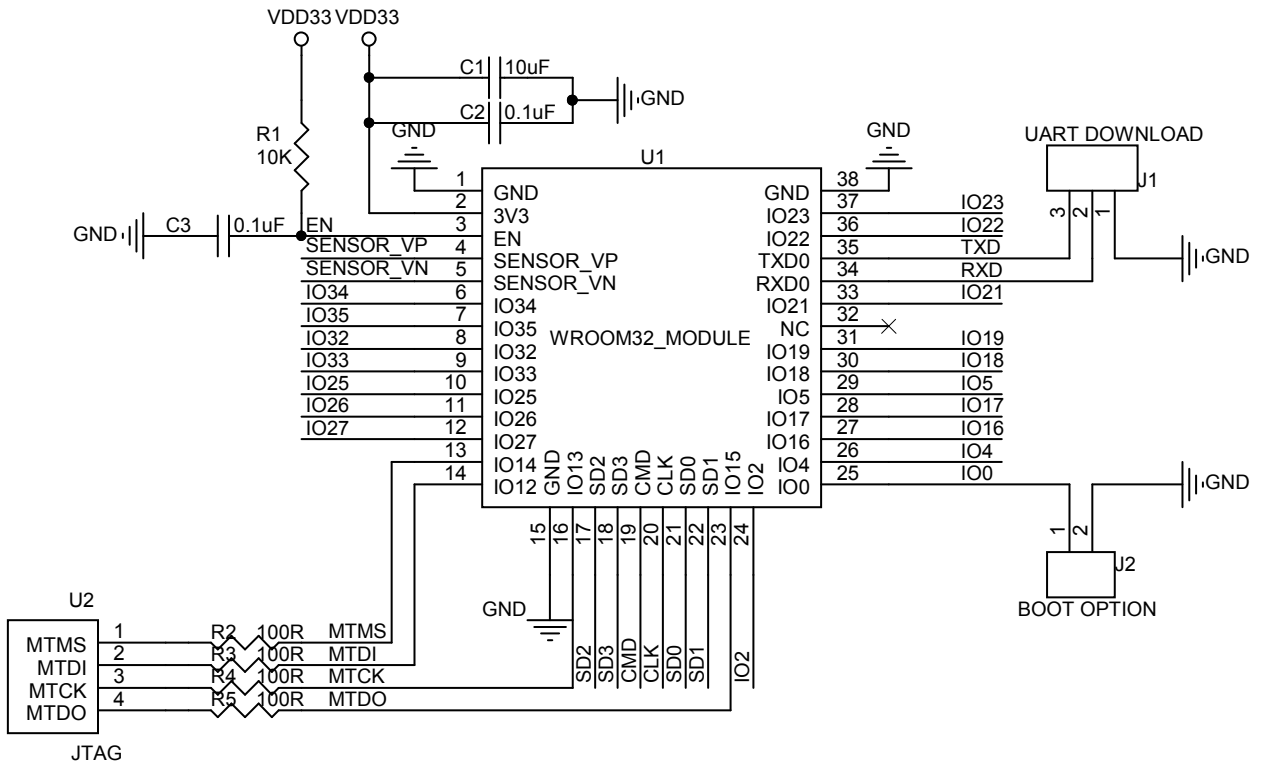


Figure 2: ESP-WROOM-32 Peripheral Schematics

**Note:**

The MTDI should be kept at low electric level.

## 4. Electrical Characteristics

**Note:**

The specifications in this chapter have been tested under the following general condition:  $V_{BAT} = 3.3V$ ,  $T_A = 27^{\circ}C$ , unless otherwise specified.

### 4.1 Absolute Maximum Ratings

**Table 7: Absolute Maximum Ratings**

| Rating                        | Condition           | Value       | Unit |
|-------------------------------|---------------------|-------------|------|
| Storage temperature           | -                   | -40 ~ 85    | °C   |
| Maximum soldering temperature | -                   | 260         | °C   |
| Supply voltage                | IPC/JEDEC J-STD-020 | +2.2 ~ +3.6 | V    |

### 4.2 Recommended Operating Conditions

**Table 8: Recommended Operating Conditions**

| Operating condition   | Symbol    | Min | Typ | Max | Unit |
|-----------------------|-----------|-----|-----|-----|------|
| Operating temperature | -         | -40 | 20  | 85  | °C   |
| Supply voltage        | VDD       | 2.2 | 3.3 | 3.6 | V    |
| Operating current     | $I_{VDD}$ | 0.5 | -   | -   | A    |

### 4.3 Digital Terminal Characteristics

**Table 9: Digital Terminal Characteristics**

| Terminals               | Symbol   | Min     | Typ | Max     | Unit |
|-------------------------|----------|---------|-----|---------|------|
| Input logic level low   | $V_{IL}$ | -0.3    | -   | 0.25VDD | V    |
| Input logic level high  | $V_{IH}$ | 0.75VDD | -   | VDD+0.3 | V    |
| Output logic level low  | $V_{OL}$ | N       | -   | 0.1VDD  | V    |
| Output logic level high | $V_{OH}$ | 0.8VDD  | -   | N       | V    |

## 4.4 Wi-Fi Radio

**Table 10: Wi-Fi Radio Characteristics**

| Description                | Min  | Typ  | Max  | Unit     |
|----------------------------|------|------|------|----------|
| General Characteristics    |      |      |      |          |
| Input frequency            | 2412 | -    | 2484 | MHz      |
| Input impedance            | -    | 50   | -    | $\Omega$ |
| Input reflection           | -    | -    | -10  | dB       |
| Output power of PA         | 15.5 | 19.5 | 21.5 | dBm      |
| Sensitivity                |      |      |      |          |
| DSSS, 1 Mbps               | -    | -98  | -    | dBm      |
| CCK, 11 Mbps               | -    | -90  | -    | dBm      |
| OFDM, 6 Mbps               | -    | -93  | -    | dBm      |
| OFDM, 54 Mbps              | -    | -75  | -    | dBm      |
| HT20, MCS0                 | -    | -93  | -    | dBm      |
| HT20, MCS7                 | -    | -73  | -    | dBm      |
| HT40, MCS0                 | -    | -90  | -    | dBm      |
| HT40, MCS7                 | -    | -70  | -    | dBm      |
| MCS32                      | -    | -91  | -    | dBm      |
| Adjacent Channel Rejection |      |      |      |          |
| OFDM, 6 Mbps               | -    | 37   | -    | dB       |
| OFDM, 54 Mbps              | -    | 21   | -    | dB       |
| HT20, MCS0                 | -    | 37   | -    | dB       |
| HT20, MCS7                 | -    | 20   | -    | dB       |

## 4.5 Bluetooth LE Radio

### 4.5.1 Receiver

**Table 11: Receiver Characteristics - BLE**

| Parameter                         | Conditions          | Min | Typ | Max | Unit |
|-----------------------------------|---------------------|-----|-----|-----|------|
| Sensitivity @0.1% BER             | -                   | -   | -98 | -   | dBm  |
| Maximum received signal @0.1% BER | -                   | 0   | -   | -   | dBm  |
| Co-channel C/I                    | -                   | -   | +10 | -   | dB   |
| Adjacent channel selectivity C/I  | F = F0 + 1 MHz      | -   | -5  | -   | dB   |
|                                   | F = F0 - 1 MHz      | -   | -5  | -   | dB   |
|                                   | F = F0 + 2 MHz      | -   | -25 | -   | dB   |
|                                   | F = F0 - 2 MHz      | -   | -35 | -   | dB   |
|                                   | F = F0 + 3 MHz      | -   | -25 | -   | dB   |
|                                   | F = F0 - 3 MHz      | -   | -45 | -   | dB   |
| Out-of-band blocking performance  | 30 MHz - 2000 MHz   | -10 | -   | -   | dBm  |
|                                   | 2000 MHz - 2400 MHz | -27 | -   | -   | dBm  |
|                                   | 2500 MHz - 3000 MHz | -27 | -   | -   | dBm  |
|                                   | 3000 MHz - 12.5 GHz | -10 | -   | -   | dBm  |
| Intermodulation                   | -                   | -36 | -   | -   | dBm  |

## 4.5.2 Transmit

Table 12: Transmit Characteristics - BLE

| Parameter                         | Conditions       | Min | Typ   | Max | Unit           |
|-----------------------------------|------------------|-----|-------|-----|----------------|
| RF transmit power                 | -                | -   | +7.5  | +10 | dBm            |
| RF power control range            | -                | -   | 25    | -   | dB             |
| Adjacent channel transmit power   | F = F0 + 1 MHz   | -   | -14.6 | -   | dBm            |
|                                   | F = F0 - 1 MHz   | -   | -12.7 | -   | dBm            |
|                                   | F = F0 + 2 MHz   | -   | -44.3 | -   | dBm            |
|                                   | F = F0 - 2 MHz   | -   | -38.7 | -   | dBm            |
|                                   | F = F0 + 3 MHz   | -   | -49.2 | -   | dBm            |
|                                   | F = F0 - 3 MHz   | -   | -44.7 | -   | dBm            |
|                                   | F = F0 + > 3 MHz | -   | -50   | -   | dBm            |
|                                   | F = F0 - > 3 MHz | -   | -50   | -   | dBm            |
| $\Delta f1_{avg}$                 | -                | -   | -     | 265 | kHz            |
| $\Delta f2_{max}$                 | -                | 247 | -     | -   | kHz            |
| $\Delta f2_{avg}/\Delta f1_{avg}$ | -                | -   | -0.92 | -   | -              |
| ICFT                              | -                | -   | -10   | -   | kHz            |
| Drift rate                        | -                | -   | 0.7   | -   | kHz/50 $\mu$ s |
| Drift                             | -                | -   | 2     | -   | kHz            |

## 4.6 Reflow Profile

Table 13: Reflow Profile

| Item   | Value                     |
|--|---------------------------|
| T <sub>s</sub> max to TL (Ramp-up Rate)                                      | 3°C/second max            |
| Preheat  |                           |
| Temperature Min. (T <sub>s</sub> Min.)                                       | 150°C                     |
| Temperature Typ. (T <sub>s</sub> Typ.)                                       | 175°C                     |
| Temperature Min. (T <sub>s</sub> Max.)                                       | 200°C                     |
| Time (T <sub>s</sub> )   | 60 ~ 180 seconds          |
| Ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )                             | 3°C/second max            |
| Time maintained above: -Temperature (T <sub>L</sub> )/Time (T <sub>L</sub> ) | 217°C/60 ~ 150 seconds    |
| Peak temperature (T <sub>P</sub> )   | 260°C max, for 10 seconds |
| Target peak temperature (T <sub>P</sub> Target)                              | 260°C +0/-5°C             |
| Time within 5°C of actual peak (t <sub>P</sub> )                             | 20 ~ 40 seconds           |
| T <sub>S</sub> max to T <sub>L</sub> (Ramp-down Rate)                        | 6°C/second max            |
| Tune 25°C to Peak Temperature (t)  | 8 minutes max             |

# 5. Schematics

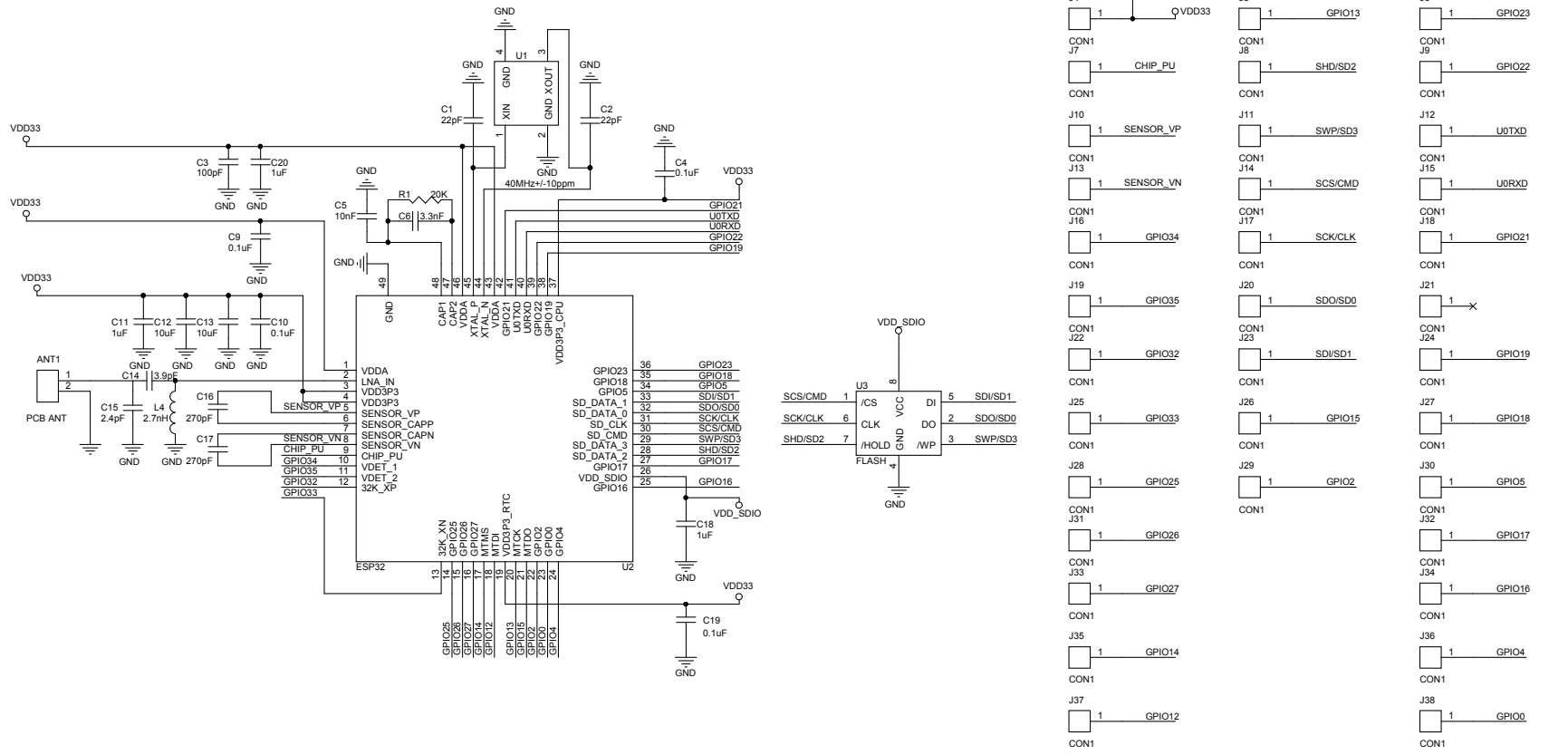


Figure 3: ESP-WROOM-32 Schematics

**Note:**  
The capacitance of C1 and C2 varies with the selection of the crystal.

## 6. Learning Resources

### 6.1 Must-Read Documents

The following link provides related documents of ESP32.

- [ESP32 Datasheet](#)  
This document provides introduction to the specifications of the ESP32 hardware, including overview, pin definitions, functional description, peripheral interface, electrical characteristics, etc.
- [ESP32 Technical Reference Manual](#)  
The manual provides detailed information on how to use the ESP32 memory and peripherals.
- [ESP32 Hardware Resources](#)  
The zip files include the schematics, PCB layout, Gerber and BOM list of ESP32-DevKitC.
- [ESP32 Pin List](#)  
This list provides a quick reference guide of the IO MUX, Ethernet MAC, GPIO Matrix, and strapping pins of ESP32.
- [ESP32 Hardware Design Guidelines](#)  
The guidelines outline recommended design practices when developing standalone or add-on systems based on the ESP32 series of products, including ESP32, the ESP-WROOM-32 module, and ESP32-DevKitC — the development board.
- [ESP32 AT Instruction Set and Examples](#)  
This document introduces the ESP32 AT commands, explains how to use them and provides examples of several common AT commands.

### 6.2 Must-Have Resources

Here are the ESP32-related must-have resources.

- [ESP32 BBS](#)  
This is an Engineer-to-Engineer (E2E) Community for ESP32 where you can post questions, share knowledge, explore ideas, and help solve problems with fellow engineers.
- [ESP32 Github](#)  
ESP32 development projects are freely distributed under Espressif's MIT license on Github. It is established to help developers get started with ESP32 and foster innovation and the growth of general knowledge about the hardware and software surrounding ESP32 devices.
- [ESP32 Tools](#)  
This is a web-page where users can download ESP32 Flash Download Tools and the zip file "ESP32 Certification and Test".
- [ESP32 IDF](#)  
This web-page links users to the official IoT development framework for ESP32.
- [ESP32 Resources](#)  
This webpage provides the links to all the available ESP32 documents, SDK and tools.